

## Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250µA, $V_{\rm GS}$ = 0V	20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			1	μA
		T <sub>J</sub> = 55°C			5	μ
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 12V$			±500	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$	0.5	0.75	1.2	V
I <sub>D(ON)</sub>	On state drain current	$V_{GS}$ = 4.5V, $V_{DS}$ = 5V	25			Α
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ = 4.5V, $I_{D}$ = 5.0A	18	24	32	mΩ
		T <sub>J</sub> =125°C	25	33	43	1115.2
		$V_{GS}$ = 4.0V, $I_{D}$ = 4.5A	22	26	34	mΩ
		V <sub>GS</sub> = 3.1V, I <sub>D</sub> = 4.5A	21	28	37	mΩ
		$V_{GS}$ = 2.5V, $I_{D}$ = 4.0A	22	31	42	mΩ
<b>g</b> fs	Forward Transconductance	$V_{DS} = 5V, I_{D} = 5.0A$		7		S
$V_{SD}$	Diode Forward Voltage	$I_{\rm S} = 1$ A, $V_{\rm GS} = 0$ V		0.65	1	V
I <sub>S</sub>	Maximum Body-Diode Continuous Cu	rrent			1.1	Α
DYNAMI	C PARAMETERS					
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =10V, f=1MHz		580	725	pF
C <sub>oss</sub>	Output Capacitance			95		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			70		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		3.5	5.3	Ω
SWITCHI	NG PARAMETERS					
Q <sub>g</sub>	Total Gate Charge			5.8	7.7	nC
Q <sub>gs</sub>	Gate Source Charge	$V_{GS}$ = 4.5V, $V_{DS}$ = 10V, $I_{D}$ = 5A		1		nC
Q <sub>gd</sub>	Gate Drain Charge	7		1.6		nC
t <sub>D(on)</sub>	Turn-On DelayTime			2.4		ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =10V, R <sub>L</sub> =2.0Ω,		6.4		ns
t <sub>D(off)</sub>	Turn-Off DelayTime	$R_{GEN}=3\Omega$		38		ns
t <sub>f</sub>	Turn-Off Fall Time	7		9.5		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =5A, dI/dt=100A/μs		18	24	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	e I <sub>F</sub> =5A, dl/dt=100A/μs		6		nC

A: The value of R  $_{6JA}$  is measured with the device mounted on 1in <sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T  $_{A}$  = 25°C. in any given application depends on the user's specific board design. The current rating is based on the t  $\leq$ 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

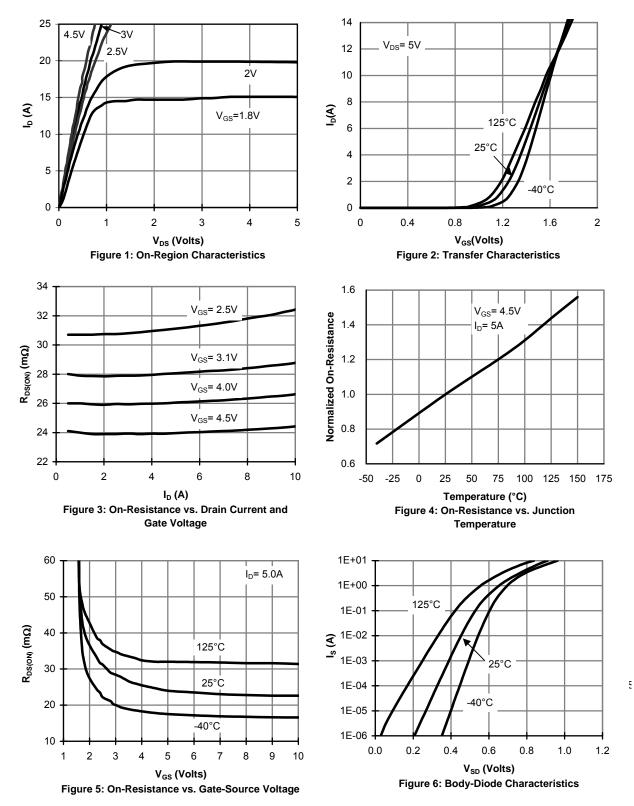
C. The R  $_{\rm 0JA}$  is the sum of the thermal impedence from junction to lead R  $_{\rm 0JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <  $300 \,\mu$ s pulses, duty cycle 0.5% max.

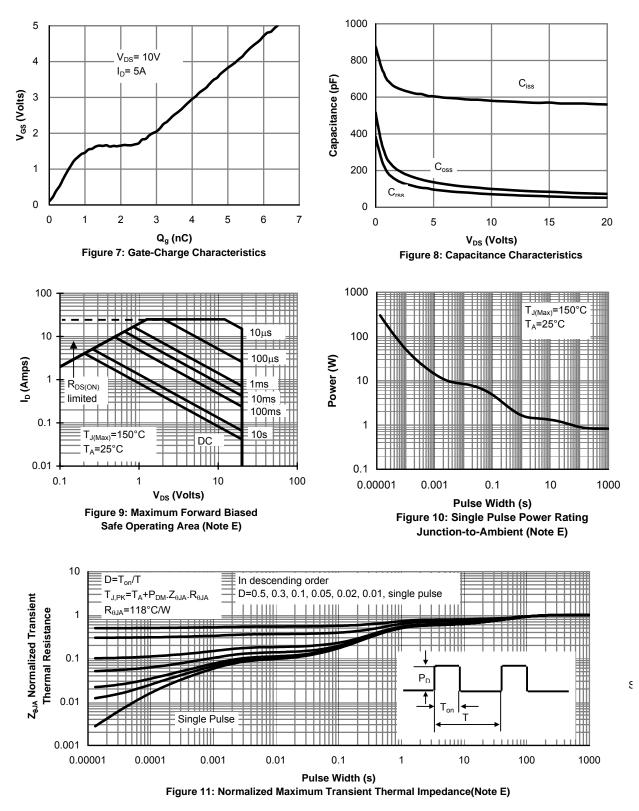
E. These tests are performed with the device mounted on 1 in  ${}^{2}$  FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C. The SOA curve provides a single pulse rating.

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